# ADM3232E\* PRODUCT PAGE QUICK LINKS

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### **DOCUMENTATION**

### Data Sheet

 ADM3232E: ±15 kV ESD Protected, 3.3 V, RS-232 Line Driver/Receiver Data Sheet

### REFERENCE MATERIALS

### **Solutions Bulletins & Brochures**

• RS-232 Transceivers Applications Bulletin (Summer 2008)

### DESIGN RESOURCES

- ADM3232E Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

### DISCUSSIONS

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### **REVISION HISTORY**

### 4/11-Rev. A to Rev. B

Changes to Features Section and General Description
Section1
Change to ESD Protection (RS-232 I/O Pins) Parameter,
Table 1
Change to ESD Protection on RS-232 Pins Section Heading 8

### 7/08—Rev. 0 to Rev. A

Added 16-Lead SOIC	Universal
Updated Outline Dimensions	9
Changes to Ordering Guide	

12/06—Revision 0: Initial Version

# **SPECIFICATIONS**

 $V_{\rm CC}$  = 3.3 V  $\pm$  0.3 V, C1 to C4 = 0.1  $\mu F;$  all specifications  $T_{\rm MIN}$  to  $T_{\rm MAX}$ , unless otherwise noted.

Table 1.	•
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Parameter	Min	Тур	Max	Unit	Test Conditions/Comments	
DC CHARACTERISTICS						
Operating Voltage Range	3.0	3.3	5.5	V		
V <sub>CC</sub> Power Supply Current		1.3	3	mA	No load	
LOGIC						
Input Logic Threshold Low, VINL			0.8	V	T <sub>IN</sub>	
Input Logic Threshold High, VINH	2.0			V	T <sub>IN</sub>	
TTL/CMOS Output Voltage Low, Vol			0.4	v	l <sub>ουτ</sub> = 1.6 mA	
TTLCMOS Output Voltage High, VOH	$V_{CC} - 0.6$			v	$I_{OUT} = -1 \text{ mA}$	
Logic Pull-Up Current		5	10	μA	$T_{IN} = GND \text{ to } V_{CC}$	
Transmitter Input Hysteresis		0.5		V		
RS-232 RECEIVER						
Input Voltage Range	-30		+30	V		
Input Threshold Low	0.6	1.2		V		
Input Threshold High		1.6	2.4	V		
Input Hysteresis		0.4		V		
Input Resistance	3	5	7	kΩ		
RS-232 TRANSMITTER						
Output Voltage Swing (RS-232)	±5.0	±5.2		V	$V_{cc}$ = 3.3 V, all transmitter outputs loaded with 3 k $\Omega$ to ground	
Output Voltage Swing (RS-562)	±3.7			V	$V_{CC} = 3.0 V$	
Transmitter Output Resistance	300			Ω	$V_{CC} = 0 V, V_{OUT} = \pm 2 V$	
Output Short-Circuit Current (RS-232)		±15		mA		
TIMING CHARACTERISTICS						
Maximum Data Rate	460			kbps	$V_{CC}$ = 3.3 V, $R_L$ = 3 k $\Omega$ to 7 k $\Omega,$ $C_L$ = 50 pF to 1000 pF, one Tx switching	
Receiver Propagation Delay						
t <sub>PHL</sub>		0.4	1	μs		
<b>t</b> PLH		0.4	1	μs		
Transmitter Propagation Delay		300	1.2	μs	$R_L = 3 k\Omega, C_L = 1000 pF$	
Receiver Output Enable Time		200		ns		
Receiver Output Disable Time		200		ns		
Transmitter Skew		30		ns		
Receiver Skew		300		ns		
Transition Region Slew Rate	5.5	10	30	V/µs	Measured from +3 V to -3 V or -3 V to +3 V, $V_{CC}$ = 3.3 V; R <sub>L</sub> = 3 k $\Omega$ , C <sub>L</sub> = 1000 pF, T <sub>A</sub> = 25°C	
ESD PROTECTION (RS-232 I/O PINS)						
		±15		kV	Human body model	
		±15		kV	IEC 1000-4-2 air discharge	
		±8		kV	IEC 1000-4-2 contact discharge	

# **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25^{\circ}C$ , unless otherwise noted.

### Table 2.

Parameter	Rating	
Vcc	–0.3 V to +6 V	
V+	$(V_{CC} - 0.3 \text{ V})$ to 14 V	
V-	+0.3 V to -14 V	
Input Voltages		
Txin	-0.3 V to (V <sub>CC</sub> + 0.3 V)	
Rx <sub>IN</sub>	±30 V	
Output Voltages		
Tx <sub>out</sub>	±15 V	
Rxout	-0.3 V to (V <sub>CC</sub> + 0.3 V)	
Short-Circuit Duration		
Тхоит	Continuous	
Power Dissipation R-16/RW-16	450 mW	
(Derate 6 mW/°C Above 50°C)		
$ heta_{JA}$ , Thermal Impedance	158°C/W	
Power Dissipation RU-16	500 mW	
(Derate 6 mW/°C Above 50°C)		
$\theta_{JA}$ , Thermal Impedance	158°C/W	
Operating Temperature Range		
Industrial (A Version)	-40°C to +85°C	
Storage Temperature Range	–65°C to +150°C	
Lead Temperature (Soldering, 10 sec)	JEDEC industry-standard J-STD-020	

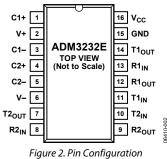
Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# **PIN CONFIGURATION AND FUNCTION DESCRIPTIONS**



### Table 3. Pin Function Descriptions

Pin No.	Mnemonic	Description
1, 3	C1+, C1–	External Capacitor 1 is connected between these pins. A 0.1 µF capacitor is recommended, but larger capacitors of up to 47 µF can be used.
2	V+	Internally Generated Positive Supply (6 V Nominal).
4, 5	C2+, C2-	External Capacitor 2 is connected between these pins. A 0.1 µF capacitor is recommended, but larger capacitors of up to 47 µF can be used.
6	V–	Internally Generated Negative Supply (–6 V Nominal).
7, 14	T2out, T1out	Transmitter (Driver) Outputs. These are RS-232 signal levels (typically $\pm 6$ V).
8, 13	R2 <sub>IN</sub> , R1 <sub>IN</sub>	Receiver Inputs. These inputs accept RS-232 signal levels. An internal 5 k $\Omega$ pull-down resistor to GND is connected on each input.
9, 12	R2out, R1out	Receiver Outputs. These are TTL/CMOS output logic levels.
10, 11	T2 <sub>IN</sub> , T1 <sub>IN</sub>	Transmitter (Driver) Inputs. These inputs accept TTL/CMOS levels.
15	GND	Ground Pin. Must be connected to 0 V.
16	V <sub>cc</sub>	Power Supply Input (3.3 V $\pm$ 0.3 V).

# **TYPICAL PERFORMANCE CHARACTERISTICS**

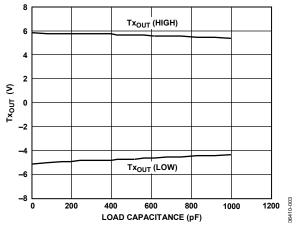


Figure 3. Transmitter Output Voltage High/Low vs. Load Capacitance @ 460 kbps

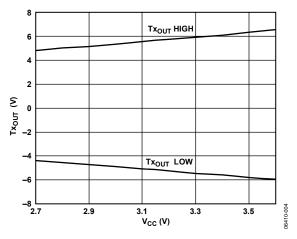


Figure 4. Transmitter Output Voltage vs. Vcc

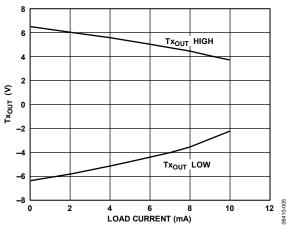


Figure 5. Transmitter Output Voltage High/Low vs. Load Current

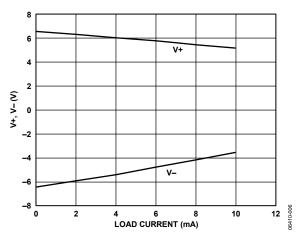


Figure 6. Charge Pump V+, V- vs. Load Current

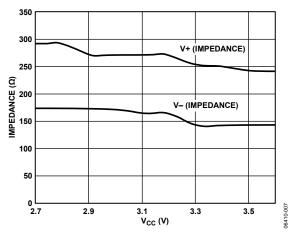
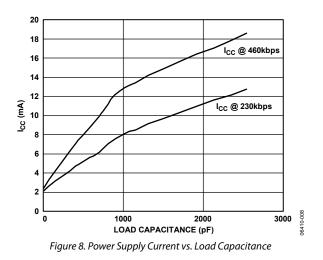
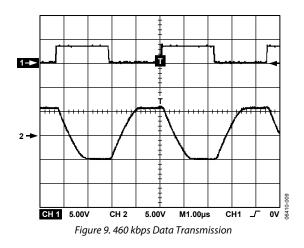


Figure 7. Charge Pump Impedance vs. V<sub>CC</sub>





# THEORY OF OPERATION

The ADM3232E is a single-channel RS-232 line driver/receiver. Step-up voltage converters, coupled with level-shifting transmitters and receivers, allow RS-232 levels to be developed while operating from a single 3.3 V supply.

CMOS technology is used to keep the power dissipation to an absolute minimum, allowing maximum battery life in portable applications.

### **CIRCUIT DESCRIPTION**

The internal circuitry consists of the following main sections:

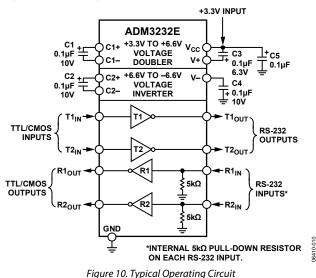
- A charge pump voltage converter
- A 3.3 V logic to RS-232 transmitter
- An RS-232 to 3.3 V logic receiver

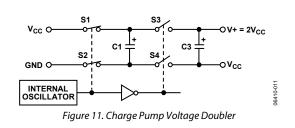
### Charge Pump Voltage Converter

The charge pump voltage converter consists of a 200 kHz oscillator and a switching matrix. The converter generates a  $\pm 6.6$  V supply from the input 3.3 V level. This is accomplished in two stages by using a switched capacitor technique as shown in Figure 10. First, the 3.3 V input supply is doubled to 6.6 V by using Capacitor C1 as the charge storage element. The +6.6 V level is then inverted to generate -6.6 V, using C2 as the storage element.

Capacitor C3 and Capacitor C4 are used to reduce the output ripple. Their values are not critical and can be increased, if desired. Capacitor C3 is shown connected between V+ and V<sub>CC</sub>. It is also acceptable to connect this capacitor between V+ and GND.

If desired, larger capacitors (up to 10  $\mu F)$  can be used for Capacitor C1 to Capacitor C4.





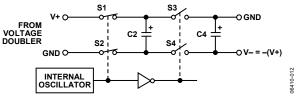


Figure 12. Charge Pump Voltage Inverter

### 3.3 V Logic to RS-232 Transmitter

The drivers convert 3.3 V logic input levels into RS-232 output levels. With  $V_{CC}$  = 3.3 V and driving an RS-232 load, the output voltage swing is typically ±6 V.

### RS-232 to 3.3 V Logic Receiver

The receivers are inverting level shifters that accept RS-232 input levels and translate them into 3 V logic output levels. The inputs have internal 5 k $\Omega$  pull-down resistors to ground and are protected against overvoltages up to ±30 V. Unconnected inputs are pulled to 0 V by the internal 5 k $\Omega$  pull-down resistor. This results in a Logic 1 output level for unconnected inputs or for inputs connected to GND.

The receivers have Schmitt trigger inputs with a hysteresis level of 0.4 V. This ensures error-free reception for both noisy inputs and for inputs with slow transition times.

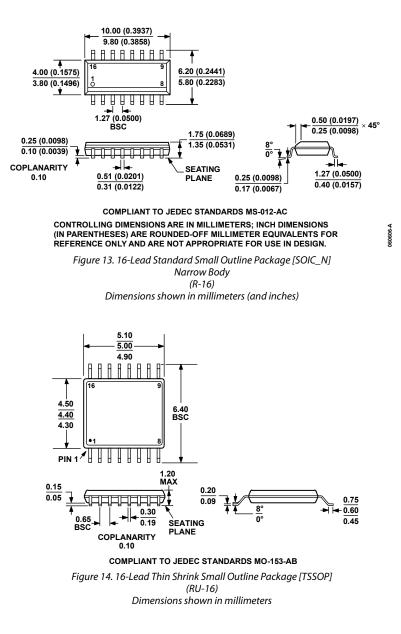
### ESD Protection on RS-232 Pins

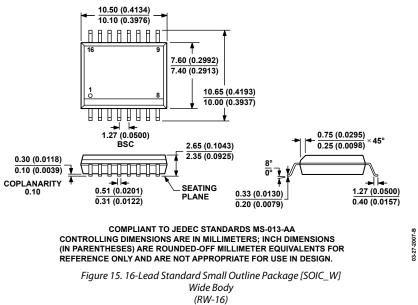
All RS-232 (Tx<sub>OUT</sub> and Rx<sub>IN</sub>) inputs and outputs are protected against electrostatic discharges (up to  $\pm 15$  kV). This ensures compliance with IEC 1000-4-2 requirements.

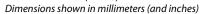
### **HIGH BAUD RATE**

The ADM3232E features high slew rates, permitting data transmission at rates well in excess of the EIA-232E specifications. RS-232 voltage levels are maintained at data rates up to 460 kbps, even under worst-case loading conditions. The slew rate is internally controlled to less than 30 V/ $\mu$ s to minimize EMI interference.

# **OUTLINE DIMENSIONS**







### **ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option
ADM3232EARNZ	–40°C to +85°C	16-Lead SOIC_N	R-16
ADM3232EARNZ-REEL7	–40°C to +85°C	16-Lead SOIC_N	R-16
ADM3232EARUZ	-40°C to +85°C	16-Lead TSSOP	RU-16
ADM3232EARUZ-REEL7	–40°C to +85°C	16-Lead TSSOP	RU-16
ADM3232EARWZ	-40°C to +85°C	16-Lead SOIC_W	RW-16
ADM3232EARWZ-REEL	–40°C to +85°C	16-Lead SOIC_W	RW-16

<sup>1</sup> Z = RoHS Compliant Part.

# NOTES

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